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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/529,904	04/01/2005	Masashi Ueda	269021US2PCT	5287

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OBLON, SPIVAK, MCCLELLAND MAIER & NEUSTADT, L.L.P.  
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ALEXANDRIA, VA 22314

EXAMINER
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MILLER, JR, JOSEPH ALBERT

ART UNIT	PAPER NUMBER
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1715

NOTIFICATION DATE	DELIVERY MODE
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05/18/2010

ELECTRONIC

**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

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<b>Office Action Summary</b>	<b>Application No.</b> 10/529,904	<b>Applicant(s)</b> UEDA ET AL.	
	<b>Examiner</b> JOSEPH MILLER JR	<b>Art Unit</b> 1715	

**-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --**

### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

### Status

- 1) ☒ Responsive to communication(s) filed on 23 April 2010.
- 2a) ☒ This action is **FINAL**.                      2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

### Disposition of Claims

- 4) ☒ Claim(s) 1,3-7 and 9-15 is/are pending in the application.
- 4a) Of the above claim(s) 5,6 and 11-15 is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1, 3, 4, 7, 9, 10 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

### Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

### Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All    b) ☐ Some \*    c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

### Attachment(s)

- |   |   |
|---|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)                    | 4) <input type="checkbox"/> Interview Summary (PTO-413)           |
| 2) <input type="checkbox"/> Notice of Draftperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____                                      |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)         | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____   | 6) <input type="checkbox"/> Other: _____                          |

## **DETAILED ACTION**

### ***Claim Rejections - 35 USC § 103***

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 1 and 7 are rejected under U.S.C. 103(a) as obvious over Ueda (WO01/19144, 6,719,876 used as translation) in view of Lohmeyer (2002/0127764) or, in the alternative, in view of Kaschmitter (5,456,763).

Ueda teaches using an array of electrodes to perform a film deposition (col 10, line 52- col 11, line 18). Ueda teaches that the electrodes function as antennas (col 5, lines 60-68) because the function of the electrodes meets the definition of an antenna, the electrodes therefore *are* antennas (there is no further definition of “antenna” that would prohibit such interpretation). The electrodes are comprised of two linear conductors (connected by a u-shape) (Figs. 1 and 3), one end (“second end of first linear conductors”) of each (15 in Fig. 3) being connected to a high frequency generator (col 6, lines 23-36) and the “second end of the second linear conductors” being commonly grounded (col 11, lines 10-15).

Ueda further teaches multiple substrates arranged between multiple layers of the electrode (i.e. antenna) arrays (col 12, lines 17-64; Figs. 4 and 5) (i.e. “a plurality of substrates on both sides and in parallel to said array antennas”).

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Regarding the claim limitation that the respective distances between the substrates array antennas and the substrates (are) substantially similar to the intervals, it would have been obvious to someone of ordinary skill in the art at the time of the invention to space the substrates from the arrays at a distance comparable to the spacing between the linear conductors based on the dimensioning of the conductors. The conductors are formed such that there is a distance L2 between conductors based upon the wavelength and frequency applied (col 7, lines 12-55), in order to create a uniform plasma density in the space between the electrodes. Since the arrays are aligned in parallel in the embodiment taught, it would be obvious to carry over this same principal to create a uniform plasma between the electrodes of different arrays, therefore it would be obvious for the distances/spaces named to be comparable.

All required claim elements are taught except for the deposition of a crystalline silicon film; Ueda teaches deposition of an amorphous film.

Lohmeyer teaches that it is known to deposit an amorphous silicon layer and convert it to microcrystalline [0011] (also [0002-0026]).

Kaschmitter teaches a process for forming microcrystalline films from amorphous silicon films for solar cells (abstract, col 45-48).

It would have been obvious to someone of ordinary skill in the art at the time of the invention to deposit the amorphous film of Ueda and convert the film to a microcrystalline film as taught by Lohmeyer and/or Kaschmitter as it would help to decrease the degradation of the efficiency under intensive illumination as taught by

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Lohmeyer [0009]. Kaschmitter implicitly teaches the preference of a microcrystalline silicon layer for a solar cell is known in the art (col 1, lines 14-32 and lines 50-59).

While Lohmeyer teaches the conversion of a film including hydrogen, examiner takes the position that Ueda's invention is not so limited by the statement of "amorphous silicon" that such modification would be obvious. Ueda makes only several statements about the silicon film being amorphous but does not discuss the structure in any detail.

Regarding claim 7, all elements are taught as described above; additionally, Ueda teaches that such a deposition may be applied to a solar cell (col 4, lines 52-55).

Claims 3 and 9 are rejected under 35 U.S.C. 103(a) as obvious over Ueda (WO01/19144, 6,719,876 used as translation) in view of Lohmeyer (2002/0127764) or in view of Kaschmitter (5,456,763) as applied to claims 1 and 7 above, respectively, and in further view of Takagi (WO 01/088221, 2004/0020432 used as translation).

The teachings of Ueda are described above. Ueda teaches the use of a chamber including antenna elements as electrodes used to generate a plasma to deposit a film on multiple substrates, but is silent on the process pressure.

Takagi teaches a plasma CVD apparatus where a number of electrode arrays (as shown in Figure 5; [0060-0063]) are arranged in a determined interval as shown in Figure 6 [0064-0066]. A plurality of substrates (items 11 in Fig. 6) is arranged on both sides and parallel to the electrode.

Takagi teaches an example of depositing an amorphous silicon film for use in a solar cell [0003; 0068-0070]. Takagi teaches an example where a deposition pressure of 1 Pa is used to deposit such a film [0070].

It would have been obvious to someone of ordinary skill in the art at the time of the invention to apply the use of a pressure of 1 Pa (or in that area) to deposit an amorphous silicon film for a solar cell as taught by Takagi to the solar cell deposition method of Ueda as one could apply such a pressure with a reasonable expectation of producing a film that would be viable for use in producing a solar cell. Ueda teaches specific interest in the production of amorphous silicon films (col 1, lines 6-14).

Claims 4 and 10 are rejected under 35 U.S.C. 103(a) as obvious over Ueda (WO01/19144, 6,719,876 used as translation) in view of Lohmeyer (2002/0127764) or in view of Kaschmitter (5,456,763) as applied to claims 1 and 7 above and in further view of Gillery (3,907,660)

Ueda's teachings are described above. Ueda teaches a method of deposition using an array of antenna elements but does not teach putting substrates in a reciprocation motion.

Gillery teaches a deposition method (abstract) where reciprocation of a substrate is used to improve the uniformity of a deposited film (col 4, line 64 – col 5, line 5).

It would have been obvious to someone of ordinary skill in the art at the time of the invention to apply the use of reciprocal motion of a substrate as taught in the deposition method of Gillery with the deposition method of Ueda as it would allow one to

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improve the uniformity of the deposition (Gillery, citation). Ueda is clearly interested in producing uniform films on the substrates (background art, particularly col 2, lines 4-6, lines 26-29).

Claims 4 and 10 are rejected under 35 U.S.C. 103(a) as obvious over Ueda (WO01/19144, 6,719,876 used as translation) in view of Lohmeyer (2002/0127764) or Kaschmitter (5,456,763) as applied to claims 1 and 7 above and in further view of Nomura (5,993,614)

Ueda's teachings are described above. Ueda teaches a method of deposition using an array of antenna elements but does not teach putting substrates in a reciprocation motion.

Nomura teaches a method of depositing on a large substrate (abstract) using an antenna to generate a plasma (col 8, line 60 and item 112, Fig. 1). Nomura teaches that the substrate may be reciprocating within the chamber to allow deposition of multiple layers in a small chamber when using large substrates (col 20, lines 20-30).

It would have been obvious to someone of ordinary skill in the art at the time of the invention to apply the use of substrate reciprocation as taught by Nomura with the large substrate (Ueda, col 1, lines 10-14) deposition method of Ueda as it would allow for one to coat multiple layers on larger substrates in a given size (small) chamber.

Claims 1 and 7 are, in the alternative, rejected under U.S.C. 103(a) as obvious over Ueda (WO01/19144, 6,719,876 used as translation) in view of Sugiyama

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(2002/0022349) and Lohmeyer (2002/0127764) as additionally evidenced by Doehtler (4,664,951), Saitoh (4,801,474), and Sharp (5,082,696).

Ueda teaches using an array of electrodes to perform a film deposition (col 10, line 52- col 11, line 18). Ueda teaches that the electrodes function as antennas (col 5, lines 60-68) because the function of the electrodes meets the definition of an antenna, the electrodes therefore *are* antennas (there is no further definition of “antenna” that would prohibit such interpretation). The electrodes are comprised of two linear conductors (connected by a u-shape) (Figs. 1 and 3), one end (“second end of first linear conductors”) of each (15 in Fig. 3) being connected to a high frequency generator (col 6, lines 23-36) and the “second end of the second linear conductors” being commonly grounded (col 11, lines 10-15).

Ueda further teaches multiple substrates arranged between multiple layers of the electrode (i.e. antenna) arrays (col 12, lines 17-64; Figs. 4 and 5) (i.e. “a plurality of substrates on both sides and in parallel to said array antennas”).

Regarding the claim limitation that the respective distances between the substrates array antennas and the substrates (are) substantially similar to the intervals, the word “substantially similar” imparts no measurable metes and bounds on the exact distances, however, it could be argued firstly that, whatever the distances/spaces, they are inherently “substantially similar”, secondly, Ueda teaches that the electrodes are formed with the same L2 (col 12, lines 16-40 and col 7, lines 12-51) and depicts (Fig. 5) substrates that are spaced evenly, therefore the fact that the elements (substrates and



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linear conductors) are spaced evenly would make the defined spacings “substantially similar” in a broad sense of the term.

All required claim elements are taught except for the deposition of a crystalline silicon film; Ueda teaches deposition of an “amorphous” film (col 1, lines 5-15).

Sugiyama teaches formation of an amorphous silicon film useful in solar cells (abstract, [0002]). Sugiyama teaches that the quality of the film can be controlled by controlling the power density (abstract, [0044-0049]). Sugiyama teaches particularly that certain settings that are used to form amorphous films can be changed and result in a microcrystalline film ([0048-49] in particular). Examiner takes the position that the formation of a microcrystalline or amorphous film is a matter of standard process optimization based on the teachings of Sugiyama.

Lohmeyer teaches that it is known to deposit an amorphous silicon layer and convert it to microcrystalline [0011] (also [0002-0026]). Lohmeyer teaches that a microcrystalline film is expected to have an improved degradation of the efficiency under intensive illumination as compared to an amorphous film [0009].

It would have been obvious to someone of ordinary skill in the art at the time of the invention to apply standard process optimization as taught by Sugiyama in order to effect a microcrystalline film as taught by Lohmeyer as it would be expected to reduce the degradation of efficiency under intensive illumination compared to an amorphous film as taught by Lohmeyer.

It is further noted that though Ueda teaches an amorphous film, it is not clear the limitations included in such a statement of an amorphous film.

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Doehler (4,664,951) teaches the use of "amorphous" materials (including silicon materials for solar cells) where amorphous materials may include materials that include some crystallinity (col 1, line 36 – col 2, line 50).

Saitoh (4,801,474) teaches that formation of amorphous or polycrystalline silicon films, wherein the category of amorphous films includes "so-called microcrystalline" silicon (col 1, lines 17-58).

Sharp (5,082,696) specifically defines that amorphous includes both non- and microcrystalline materials but not including polycrystalline materials (col 2, lines 30-65).

While these teachings do not make obvious the formation of a microcrystalline film by Ueda, they lend support to a broader interpretation wherein Ueda could be construed as teaching non-polycrystalline film formation and therefore make obvious, in combination with Lohmeyer and Sugiyama, the formation of microcrystalline silicon films.

Regarding claim 7, all elements are taught as described above; additionally, Ueda teaches that such a deposition may be applied to a solar cell (col 4, lines 52-55).

### ***Response to Arguments***

Applicant's arguments filed 04/23/2010 have been fully considered but they are not persuasive.

Regarding applicants comments in regards to "substantially similar" versus "substantially equal", examiner would like to clarify/comment on the applicant's

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statement that the term "substantial equal" was overlooked. Though the term was not specifically stated in the office action mailed 01/27/2010, examiner takes the position that *the subject matter was addressed* - in essence the failure to change the term was a typographical error. As examiner stated per phone calls/message summarized in the Interview Summary mailed 04/28/2010, the subject matter was considered addressed in the "In alternative" paragraph of the previous Office Action on page 4. (The original argument (bottom of page 3 of action mailed on 01/27/2010) has been withdrawn from the office action as not pertinent to current claims.)

The argument on page 4 "In alternative" is an obviousness argument applicable to the choice of phrase "substantially equal" in the same manner as "substantially similar". The examiner's argument is that Ueda is concerned with distances and sizes of electrode components in order to generate the appropriate plasma as related to the substrate (col 7, lines 31-50) in particular and one carrying out the invention would, given no further specific guidance, use similar principles in spacing in order to effect an appropriate plasma between the conductors and the substrate. The discussion of uniform plasma is further addresses at col 8, lines 9-27.

In the context of the examiner's (in alternative) argument and in light of the claims, substantially similar and substantial equal present are synonymous. The examiner's point of view is that one would choose substantially similar or substantially equal spacings in all dimensions in order that uniform plasma effects the substrate(s).

In light of examiner's position that the "in alternative" argument applies to the phrase "substantially equal", it is noted that applicants have made no arguments as

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applied to examiner's reasoning included in the office action. More specifically, applicants do not argue against Ueda's teaching of uniform plasma which is the basis of examiner's arguments/motivation for forming "substantially equal/similar" distances. Further, though applicants amended claims on 12/10/2009 to "substantially equal", no arguments as to how this overcomes the art or examiner's position.

Applicants do argue (p3 of reply) that examiner argues that distances should be equal because other distances may be equal - but this is not the case. Examiner points to arguments related to formation of and exposure of the substrate to uniform plasma. Regarding applicant's citation of MPEP 2141.02 that it is incorrect to distill an invention down to the thrust, examiner takes the position that the equal spacing is sufficiently taught by Ueda and does not inappropriately distill the claimed invention as purported. The MPEP section cited is concerned with overlooking other relevant claimed details – the particular citation is included below and the cited case discusses express limitations that were overlooked in that case. Examiner can find no express claim limitation that is overlooked due to this interpretation of Ueda's teachings. Applicant's specifically cite examiner's statement of obviousness but omit the motivation (suggested by Ueda's teaching) of a uniform plasma (applicant's restated "it would be obvious to carry over this same principal" p3 of reply – without noting that examiner gave a reason/motivation along with the obviousness statement). Applicants also do not address how specifically such an interpretation in fact inappropriately distills down the instant claims.

## II. DISTILLING THE INVENTION DOWN TO A "GIST" OR "THRUST" OF AN INVENTION DISREGARDS "AS A WHOLE" REQUIREMENT

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Distilling an invention down to the “gist” or “thrust” of an invention disregards the requirement of analyzing the subject matter “as a whole.” *W.L. Gore & Associates, Inc. v. Garlock, Inc.*, 721 F.2d 1540, 220 USPQ 303 (Fed. Cir. 1983), cert. denied, 469 U.S. 851 (1984) (restricting consideration of the claims to a 10% per second rate of stretching of unsintered PTFE and disregarding other limitations resulted in treating claims as though they read differently than allowed); *Bausch & Lomb v. Barnes-Hind /Hydrocurve, Inc.*, 796 F.2d 443, 447-49, 230 USPQ 416, 419-20 (Fed. Cir. 1986), cert. denied, 484 U.S. 823 (1987) (District court focused on the “concept of forming ridgeless depressions having smooth rounded edges using a laser beam to vaporize the material,” but “disregarded express limitations that the product be an ophthalmic lens formed of a transparent cross-linked polymer and that the laser marks be surrounded by a smooth surface of unsublimated polymer.”). See also *Jones v. Hardy*, 727 F.2d 1524, 1530, 220 USPQ 1021, 1026 (Fed. Cir. 1984) (“treating the advantage as the invention disregards statutory requirement that the invention be viewed as a whole”); *Panduit Corp. v. Dennison Mfg. Co.*, 810 F.2d 1561, 1 USPQ2d 1593 (Fed. Cir.), cert. denied, 481 U.S. 1052 (1987) (district court improperly distilled claims down to a one word solution to a problem).

Regarding applicant arguments (pg 4) over “improper rationale”, applicants argue that the prior art is not applicable because the claims do not recite both converting an amorphous silicon layer into microcrystalline and forming microcrystalline from amorphous silicon. Instant claims are written as “a thin film formation method” wherein an antenna array is used. Claims are ‘comprising’ do not particularly limit the film formed only by exposure to the array of elements. Any teaching of modifying the film even after initially deposited is sufficient for a teaching of *forming* such microcrystalline structured thin films. The amorphous film would be deposited by the method of Ueda and then converted to microcrystalline as taught by either Lohmeyer or Kaschenmitter for the reasons discussed (related to the films use in solar applications). Instant claims may allow for the direct deposition of microcrystalline films, but they are also open to deposition of an amorphous film and conversion to microcrystalline.

In response to applicant's argument that the references fail to show certain features of applicant's invention related to the "unexpected results" (p5, section 3 of reply), it is noted that the features upon which applicant relies (i.e., "the thin films formed by this process, **without any conversion process**") are not recited in the rejected claim(s). Although the claims are interpreted in light of the specification, limitations from the specification are not read into the claims. See *In re Van Geuns*, 988 F.2d 1181, 26 USPQ2d 1057 (Fed. Cir. 1993). The claim is comprising and the "forming of the thin films" may include other steps and additionally may include other steps in order to effect the microcrystallinity. Applicants further argue about the controllability of the ratio of microcrystalline to amorphous but instant claim is not even limited to any particular ratios or even any amorphous component.

If there are unexpected results of the method, the limitations which produce the results which are unexpected should be included in the claim language.

Regarding the interpretation of "amorphous" and "microcrystalline", examiner agrees with applicants that alternate teachings that amorphous material may include microcrystalline structure does not mean that Ueda includes such material. However, it is applied only as evidence that the Ueda's statement should not be interpreted so strictly as to specifically exclude microcrystalline structure, or, particularly (as applied in this alternative rejection), the ability of the process to be modified (as suggested by Sugiyama) to produce microcrystalline material.

Applicant's comments regarding the treatment of amorphous versus microcrystalline phases are noted, however, the treatment of the materials as different phases does not carry over to suggest that one can not refer to a film of amorphous and microcrystalline material broadly as one or the other. Applicant's own specification teaches (in the same "Background Art" section) "a thin film formation apparatus for the deposition of *microcrystalline Si* thin film is also desired" – however, the specification refers *throughout to mixed films of amorphous and microcrystalline material*. So, applicants refer to mixed films as being produced in an apparatus for the formation of microcrystalline films – thereby supporting examiner's viewpoint on the breadth of these terms in including material that is not distinctly one or the other phase.

Furthermore, the rejection could be made equally without the evidentiary references - Sugiyama teaches the method one could use (control of the power density) to modify the film of Ueda and Lohmeyer teaches the desire to form microcrystalline layer. The evidentiary references serve to show that the material composing the microcrystalline and amorphous films could be formed within the same film.

### ***Conclusion***

**THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within

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TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to JOSEPH MILLER JR whose telephone number is (571)270-5825. The examiner can normally be reached on Mon-Thurs, 7am-4pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Timothy Meeks can be reached on (571) 272-1423. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.



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